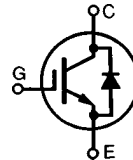


Ultra-Low $V_{CE(sat)}$ IGBT with Diode

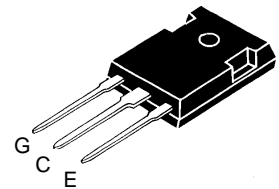
IXGH 38N60U1

$V_{CES} = 600 \text{ V}$
 $I_{C25} = 76 \text{ A}$
 $V_{CE(sat)} = 1.8 \text{ V}$

Combi Pack



TO-247 AD



G = Gate, C = Collector,
E = Emitter, TAB = Collector

| Symbol | Test Conditions | Maximum Ratings | |
|---|---|----------------------------------|------------------|
| V_{CES} | $T_J = 25^\circ\text{C}$ to 150°C | 600 | V |
| V_{CGR} | $T_J = 25^\circ\text{C}$ to 150°C ; $R_{GE} = 1 \text{ M}\Omega$ | 600 | V |
| V_{GES} | Continuous | ± 20 | V |
| V_{GEM} | Transient | ± 30 | V |
| I_{C25} | $T_C = 25^\circ\text{C}$ | 76 | A |
| I_{C90} | $T_C = 90^\circ\text{C}$ | 38 | A |
| I_{CM} | $T_C = 25^\circ\text{C}$, 1 ms | 152 | A |
| SSOA (RBSOA) | $V_{GE} = 15 \text{ V}$, $T_{VJ} = 125^\circ\text{C}$, $R_G = 10 \Omega$ Clamped inductive load, $L = 100 \mu\text{H}$ | $I_{CM} = 76$ @ $0.8 V_{CES}$ | A |
| P_C | $T_C = 25^\circ\text{C}$ | 200 | W |
| T_J | | -55 ... +150 | $^\circ\text{C}$ |
| T_{JM} | | 150 | $^\circ\text{C}$ |
| T_{stg} | | -55 ... +150 | $^\circ\text{C}$ |
| M_d | Mounting torque (M3) | 1.13/10 | Nm/lb.in. |
| Weight | | 6 | g |
| Maximum lead temperature for soldering 1.6 mm (0.062 in.) from case for 10 s | | 300 | $^\circ\text{C}$ |

Features

- International standard package JEDEC TO-247 AD
- IGBT and anti-parallel FRED in one package
- 2nd generation HDMOS™ process
- Low $V_{CE(sat)}$
 - for minimum on-state conduction losses
- MOS Gate turn-on
 - drive simplicity
- Fast Recovery Epitaxial Diode (FRED)
 - soft recovery with low I_{RM}

Applications

- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switch-mode and resonant-mode power supplies

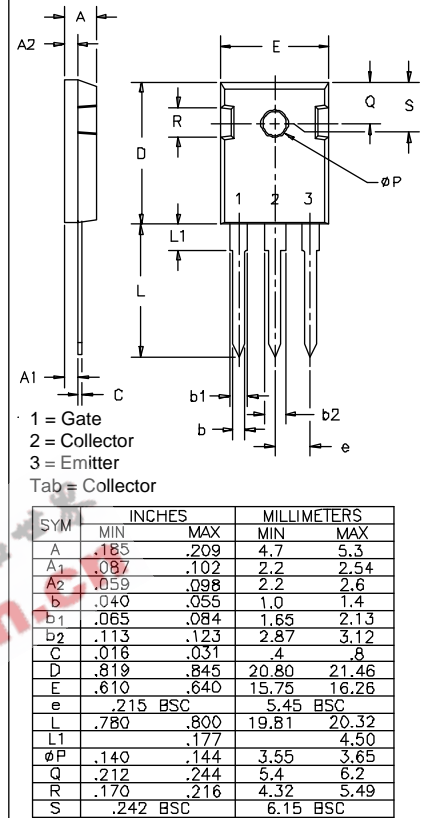
Advantages

- Space savings (two devices in one package)
- Easy to mount with 1 screw (isolated mounting screw hole)
- Reduces assembly time and cost
- High power density

| Symbol | Test Conditions | Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified) | | |
|---------------|--|---|------|---------------------------|
| | | min. | typ. | max. |
| BV_{CES} | $I_C = 750 \mu\text{A}$, $V_{GE} = 0 \text{ V}$ | 600 | | V |
| $V_{GE(th)}$ | $I_C = 250 \mu\text{A}$, $V_{CE} = V_{GE}$ | 2.5 | | 5.5 V |
| I_{CES} | $V_{CE} = 0.8 \cdot V_{CES}$ $V_{GE} = 0 \text{ V}$ | | | 500 μA 8 mA |
| I_{GES} | $V_{CE} = 0 \text{ V}$, $V_{GE} = \pm 20 \text{ V}$ | | | $\pm 100 \text{ nA}$ |
| $V_{CE(sat)}$ | $I_C = I_{C90}$, $V_{GE} = 15 \text{ V}$ | | | 1.8 V |

| Symbol | Test Conditions | Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified) | | | |
|--------------|--|---|------|----------|----|
| | | min. | typ. | max. | |
| g_{fs} | $I_C = I_{C90}$; $V_{CE} = 10\text{ V}$, Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$ | 15 | 20 | S | |
| C_{ies} | $V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 1\text{ MHz}$ | | 2500 | pF | |
| C_{oes} | | | 270 | pF | |
| C_{res} | | | 70 | pF | |
| Q_g | $I_C = I_{C90}$, $V_{GE} = 15\text{ V}$, $V_{CE} = 0.5 V_{CES}$ | | 125 | nC | |
| Q_{ge} | | | 23 | nC | |
| Q_{gc} | | | 50 | nC | |
| $t_{d(on)}$ | Inductive load, $T_J = 25^\circ\text{C}$ | | 30 | ns | |
| t_{ri} | $I_C = I_{C90}$, $V_{GE} = 15\text{ V}$, $L = 100\ \mu\text{H}$, $V_{CE} = 0.8 V_{CES}$, $R_G = R_{off} = 10\ \Omega$ | | 150 | ns | |
| $t_{d(off)}$ | | | 600 | 1200 | ns |
| t_{fi} | Remarks: Switching times may increase for $V_{CE}(\text{Clamp}) > 0.8 \cdot V_{CES}$, higher T_J or increased R_G | | 500 | 700 | ns |
| E_{off} | | | 9 | 15 | mJ |
| $t_{d(on)}$ | Inductive load, $T_J = 125^\circ\text{C}$ | | 40 | ns | |
| t_{ri} | $I_C = I_{C90}$, $V_{GE} = 15\text{ V}$, $L = 100\ \mu\text{H}$ | | 160 | ns | |
| E_{on} | | $V_{CE} = 0.8 V_{CES}$, $R_G = R_{off} = 10\ \Omega$ | | 1 | mJ |
| $t_{d(off)}$ | Remarks: Switching times may increase for $V_{CE}(\text{Clamp}) > 0.8 \cdot V_{CES}$, higher T_J or increased R_G | | 800 | ns | |
| t_{fi} | | | 1000 | ns | |
| E_{off} | | | 15 | mJ | |
| R_{thJC} | | | | 0.62 K/W | |
| R_{thCK} | | 0.25 | | K/W | |

TO-247 AD Outline



Reverse Diode (FRED)

| Symbol | Test Conditions | Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified) | | | |
|------------|--|---|------|-------|----|
| | | min. | typ. | max. | |
| V_F | $I_F = I_{C90}$, $V_{GE} = 0\text{ V}$, Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle $d \leq 2\%$ | | | 1.6 V | |
| I_{RM} | $I_F = I_{C90}$, $V_{GE} = 0\text{ V}$, $-di_F/dt = 240\text{ A}/\mu\text{s}$ $V_R = 360\text{ V}$ $T_J = 125^\circ\text{C}$ $I_F = 1\text{ A}$; $-di/dt = 100\text{ A}/\mu\text{s}$; $V_R = 30\text{ V}$ $T_J = 25^\circ\text{C}$ | | 10 | 15 | A |
| t_{rr} | | | 150 | | ns |
| | | | 35 | 50 | ns |
| R_{thJC} | | | | 1 K/W | |

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETS and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,881,106 5,017,508 5,049,961 5,187,117 5,486,715
4,850,072 4,931,844 5,034,796 5,063,307 5,237,481 5,381,025